

Shenzhen Jianghe New Materials Technology Co.,Ltd

Technical Data Sheet (TDS)

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2120A+588B-K

Typical Properties

Epoxy Resin 2120A+588B-K cures effectively at both ambient and elevated temperatures, delivering high transparency, excellent surface gloss, and superior self-debubbling performance.

Applications

Epoxy Resin 2120A+588B-K is specifically engineered for floor surface coating (primer), module potting, mold casting, and electronic component protection including insulation, moisture-proof encapsulation, and secure shielding. It is also suitable for mixing with sand or stone as a paving base material.

Physical & Chemical Properties

Property	Part A: 2120A	Part B: 588B-K
Color	Light blue, Transparent	Light blue, Transparent
Density (g/cm ³)	1.02±0.03	1±0.02
Viscosity (mPa•s)	1000±500	300±50
Mix Ratio (by Weight)	2 : 1	

Properties of Cured Material

Property	Base + Curing Agent
Physical State	Liquid
Viscosity (mPa·s)	700±100mPa.S
Pot Life (50g mass @ 25°C)	30±5 min

Processing & Curing Parameters

Initial Cure (2mm thickness, 20°C)	13 hours, 80D
Full Cure (2mm thickness, 20°C)	24 hours
Service Temperature Range	< 70°C

Application Instructions

Working Conditions: Ensure the mixing container is clean. Measure Components A and B strictly by the designated weight ratio. After accurate weighing, stir the mixture thoroughly in a clockwise direction, scraping the inner walls of the container. Allow the mixture to rest for 3-5 minutes before application.

Precautions

- Dosage Control:** Prepare the adhesive quantity based on the pot life and application rate to avoid waste.
- Low-Temperature Handling:** When the ambient temperature falls below 15°C, preheat Component A to 30°C before mixing to facilitate easier application, as the viscosity increases in cold conditions.
- Storage After Use:** The container must be sealed immediately after use to prevent moisture absorption, which can render the product unusable.
- High-Humidity Curing:** At relative humidity levels above 85%, the cured surface is prone to absorbing moisture from the air, forming a whitish haze. Therefore, room temperature curing is not recommended under these conditions; heat-assisted curing is advised.

Test Result

Hardness	Shore D	85±3
Flexural Strength	Kg/mm2	27
Heat Deflection Temperature	°C	48
Water Absorption	%	<0.1
Compressive Strength	Kg/mm2	8.3

Save

Freeze-Sensitive	Yes	
Moisture-Sensitive	Resin	Curing Agent
	No	Sensitive
Recommended Storage Temperature	15°C to 25°C (Must not fall below 10°C or exceed 50°C.)	
Shelf Life	6 months in original, unopened packaging	
Packaging	Resin	Curing Agent
	5 kg pail	5 kg pail

Note: The performance data provided above are typical values obtained under laboratory conditions of 25°C and 70% relative humidity. They are for reference purposes only.